

Product Features:

- Low Current Consumption
- Ultra-Miniature Package
- RoHS Compliant
- Analog Temperature Compensation

Applications:

- GPS, GPS Module
- CDMA / WCDMA
- 802.11 / Wifi
- T1/E1, T3/E3

Output Specifications

Frequency	13.000MHz to 52.000MHz (Contact Sales Channel for Available Frequencies)
Frequency Tolerance	±2.0 ppm (at +25°C±3°C, referenced to nominal freq., 60 minutes after 2nd reflow)
Frequency Stability	±0.5 ppm Maximum (Inclusive of Operating Temperature Range)
Frequency Stability vs. Temperature	
Frequency Stability Vs. Voltage	
Frequency Stability Vs. Load	±0.2 ppm Maximum (±5%)
Aging (at 25°C)	±1.0 ppm Maximum First Year
Supply Voltage (Vcc)	See Part Number Guide; Tolerance ±5%
Input Current (Icc)	1.5mA Maximum (Nominal Frequency less than or equal to 26.000MHz) 2.0mA Maximum (Nominal Frequency less than or equal to 32MHz) 2.5mA Maximum (Nominal Freq. over 32MHz)
Start-up Time	3mSec Maximum
Output Level	0.8Vp-p Minimum -8dBc Maximum 10kOhms//10pF
Clipped Sinewave	
Harmonics	
Output Load	
SSB Phase Noise (at 25°C, Typ.)	-87dBc/Hz at 10Hz offset -112dBc/Hz at 100Hz offset -135dBc/Hz at 1kHz offset -145dBc/Hz at 10kHz offset
Operating Temperature Range	See Part Number Guide

Absolute Maximum Rating

Storage Temperature	-40°C to +85°C
Supply Voltage (Vcc)	-0.6 VDC to +4.6 VDC
Control Voltage (Vc)	-0.6 VDC to Vcc ±0.5 VDC (I743 Only)

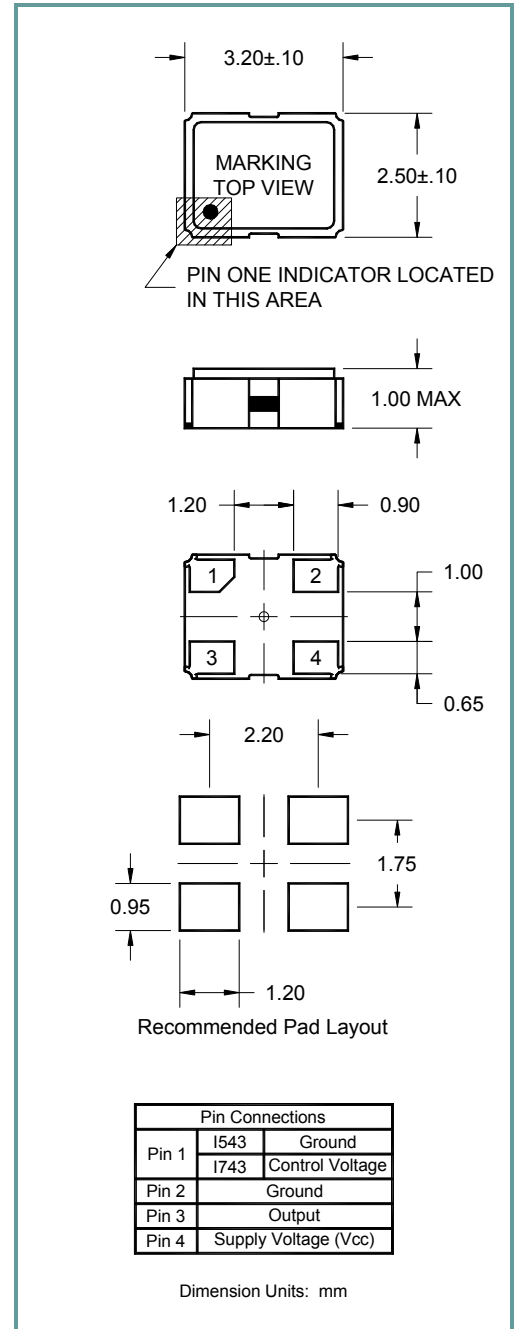
Voltage Control Characteristics

Frequency Deviation	±5ppm Minimum
Control Voltage Center and Range	1.5Vdc ±1.0Vdc
Slope	Positive
Linearity	±10%
Input Impedance	500kOhms Minimum

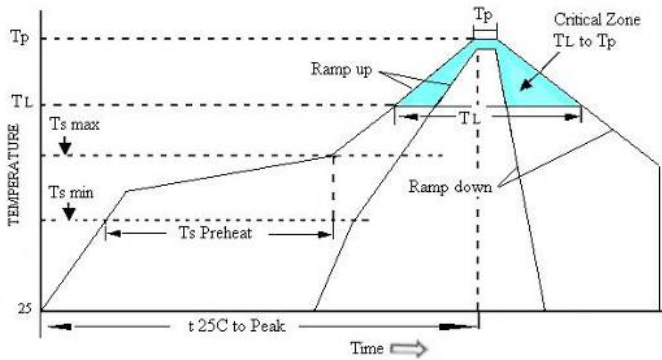
Part Number Guide

Sample Part Number: I587-5Y3-26.000 MHz

Package	Operating Temperature Range	Frequency Stability vs. Temperature	Supply Voltage	Frequency	Suffix
I543 (Clipped Sinewave TCXO)	5 = -30°C to +85°C	Y = ±0.5 ppm Max	3 = +3.3 VDC	XX.XXX or XX.XXXX = Nominal Frequency (5 or 6 Digits + Decimal)	MHz = Megahertz
I743 (Clipped Sinewave VCTCXO)			7 = +3.0 VDC		
			8 = +2.8 VDC		



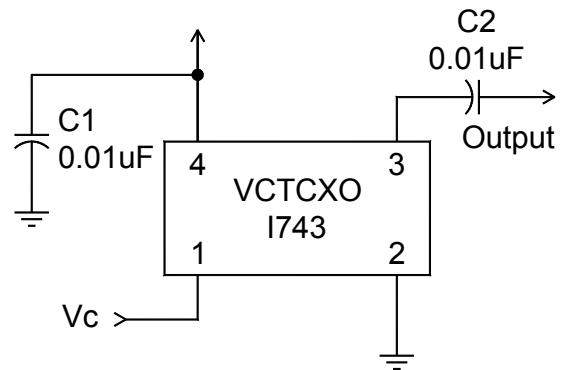
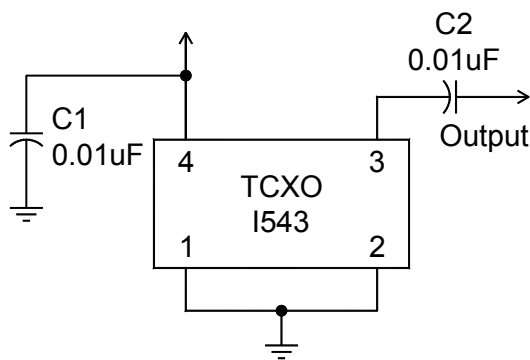
Pb Free Solder Reflow Profile:



Units are backward compatible with +240°C reflow processes

Ts max to T_l (Ramp-up Rate)	3°C / second max
Preheat	
Temperature min (T_s min)	150°C
Temperature typ (T_s typ)	175°C
Temperature max (T_s max)	200°C
Time (T_s)	60 to 180 seconds
Ramp-up Rate (T_l to T_p)	3°C / second max
Time Maintained Above Temperature (T_l)	217°C
Time (T_l)	60 to 150 seconds
Peak Temperature (T_p)	260°C max for seconds
Time within 5°C to Peak Temperature (T_p)	20 to 40 seconds
Ramp-down Rate	6°C / second max
Tune 25°C to Peak Temperature	8-minute max
Moisture Sensitivity Level (MSL)	Level 1

Circuit Configuration:



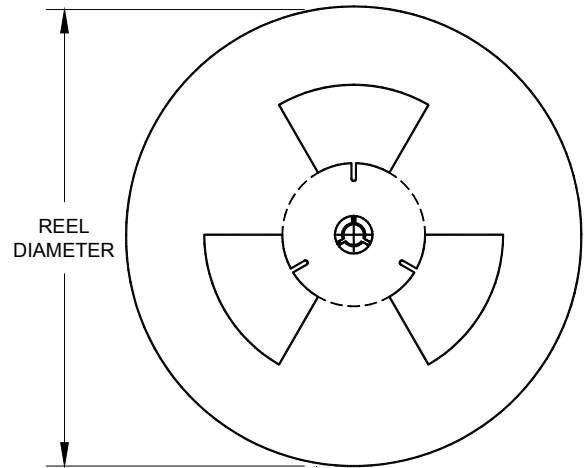
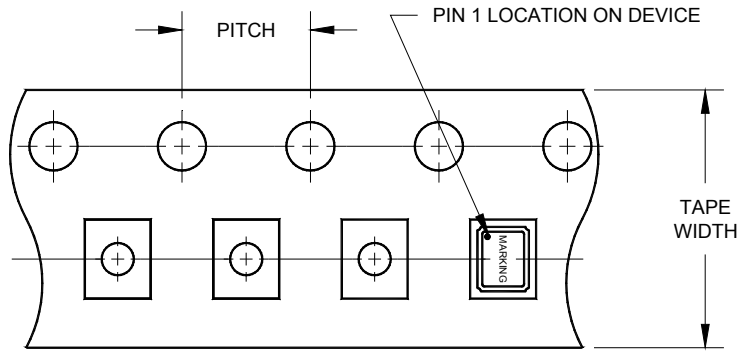
Notes:

- It is recommended that a 0.01 μ F bypass capacitor be connected between Vcc (Pin 4) and Ground (Pin 2) to minimize power supply noise.
- It is recommended that an external 0.01 μ F AC-coupling capacitor be connected to output (Pin 3) of the device.
- For the TCXO (I543) Pin 1 should not be left floating but must be connected to ground.

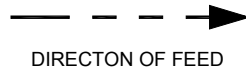
Environmental Specifications:

Thermal Shock	MIL-STD-883, Method 1011, Condition A
Moisture Resistance	MIL-STD-883, Method 1004
Mechanical Shock	MIL-STD-883, Method 2002, Condition B
Mechanical Vibration	MIL-STD-883, Method 2007, Condition A
Resistance to Soldering Heat	J-STD-020C, Table 5-2 Pb-free devices (except 2 cycles max)
Hazardous Substance	Pb-Free / RoHS / Green Compliant
Solderability	JESD22-B102-D Method 2 (Preconditioning E)
Terminal Strength	MIL-STD-883, Method 2004, Test Condition D
Gross Leak	MIL-STD-883, Method 1014, Condition C
Fine Leak	MIL-STD-883, Method 1014, Condition A2, R1=2x10 ⁻⁸ atm cc/s
Solvent Resistance	MIL-STD-202, Method 215

Tape and Reel Information:



PITCH:	4.00
TAPE WIDTH:	8.00
REEL DIAMETER:	180
QTY PER REEL MAX:	3000
Compliant to EIA-481	
All Dimensions in Millimeters	



Package Information:

MSL = 1
Termination = e4 (Au over Ni over W base metallization)

Marking:

Line 1: I-Date Code (yww)
Line 2: Frequency

PROPRIETARY AND CONFIDENTIAL

THIS DOCUMENT CONTAINS PROPRIETARY INFORMATION, AND SUCH INFORMATION MAY NOT BE DISCLOSED TO OTHERS FOR ANY PURPOSE NOR USED FOR MANUFACTURING PURPOSES WITHOUT WRITTEN PERMISSION FROM ILSI America.